Closing the loop: Circular economy for telecom operators

Leandro Navarro Co-rapporteur Q7/5 ITU



ITU-T Study Group 5: EMF, environment, climate action, sustainable digitalization and circular economy, develops standards on:

- Electromagnetic compatibility, resistibility and lightning protection
- Soft error caused by particle radiations
- Human exposure to electromagnetic fields
- Circular economy and e-waste management
- ICTs related to the environment, energy efficiency, clean energy and sustainable digitalization for climate actions

Question 7 in study group 5:

"E-waste, circular economy, and sustainable supply chain management"

Technical alignment of standards with European ETSI Environmental Engineering

Focus on circularity and transparency about environmental and climate change aspects



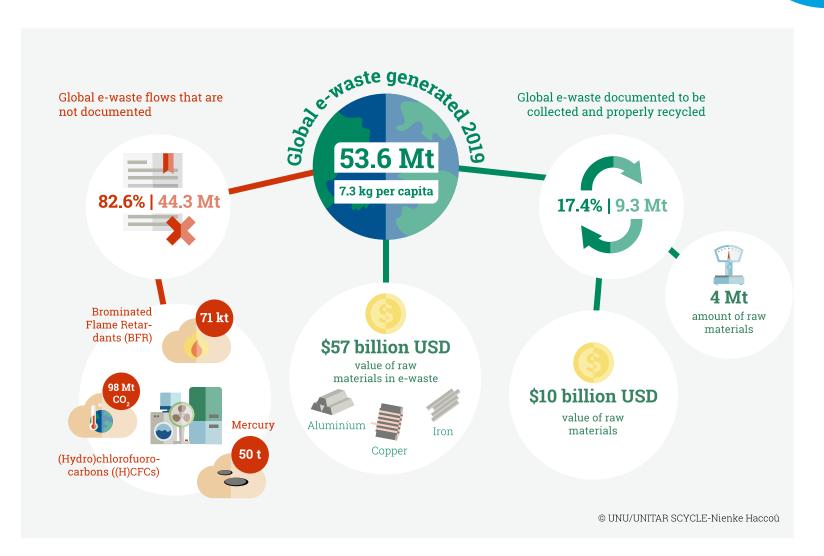
ITU-T Q7/SG5:

"E-waste, circular economy, and sustainable supply chain management"

- 2012 Rare metals: L.1100 recycling,
 2014 L.1101 measurement, 2016 L.1102 digital labels
- 2018 L.1020, 2020 L.1021,
 2021 L.1022 circular economy principles in the ICT sector
- 2020 L.1023: Assessment method for circular scoring (ecodesign), rev. 2023
- 2020 L.1024 Impact of servitisation (circular business models)
- 2021 L.1033: Guidance for **institutions of higher learning** to contribute in the effective life cycle management of e-equipment and e-waste
- 2021 Digital product passport: L.GDSPP, L.D4PI 2022 (w ETSI)
- 2022 L.1035 Sustainable management of batteries,
 2023-4 L.DLB durability of Lithium-ion batteries
- 2023 L.1061 Circular public procurement
- 2023 L.ME_DD, L.GPSIM secure deletion, L.ME_AF firmware updates
- 2023-4 L.suppl.GSP Green supply chain management, L.SCCA carbon accounting
- 2023 L.1070 "Global digital sustainable product passport opportunities to achieve a circular economy"
- 2024 L.D4PI "An information model for digital product information on sustainability and circularity"



We produce every year as many e-devices as people alive!



Importance of circular economy













Improvements

- in electricity supply
- in material and energy efficiency of ICT devices and networks
- In addition to / replacement
- In the circular economy ...
 - Durability, long lifespan
 - Multiple cycles
 - Business models: Servitisation
- More information, verifiable claims
- Better accountability
 - Product information, impacts



Digitisation Digital transformation

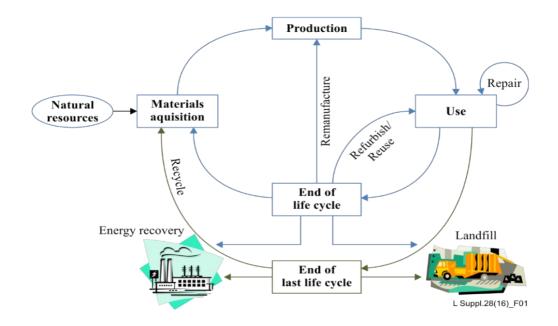
- Related Standards: material datasheets, databases, data carriers, storage, technical data interop protocols, etc.
- Digital transformation concerns most if not all product categories: EEE, ICT, but also plastics, textile, vehicles, buildings, etc.



Improve the environmental sustainability of products, EC Sustainable Product Initiative 2020+

- Requirements related to product durability, reusability, upgradability and reparability, the presence of substances of concern in products, product energy and resource efficiency, recycled content in products, product remanufacturing and high-quality recycling, and for reducing products' carbon and environmental footprints.
- Improve products environmental sustainability and access to sustainability information along the supply chain.
- Incentivise more sustainable products and business models to improve value retention.
- Improve application of sustainable product legislative framework.





Eco-design of products and services

Reuse

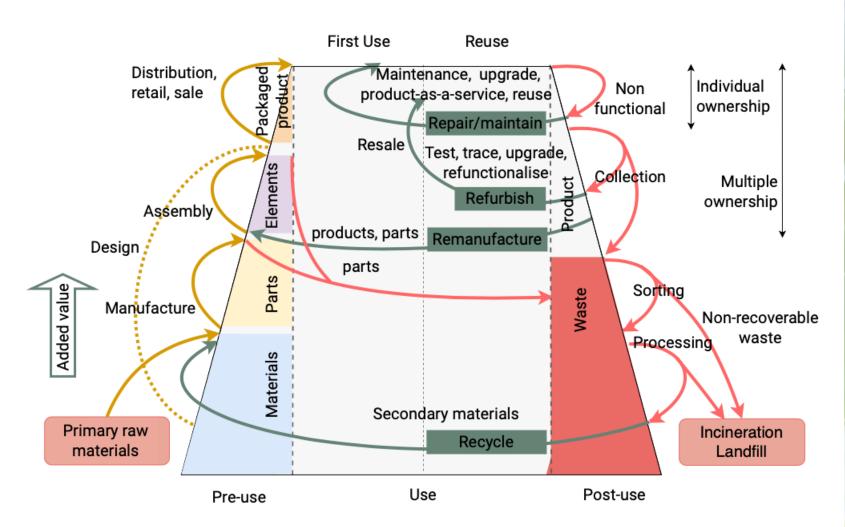
Optimising life cycle and end-of-life

Selling repairable products

e-waste

Knowing helps digital information about products







Requirements of reporting key aspects related to circularity and transparency of an ICT or digital technology product in digital format.

Facilitate and automate analysis of different ICT products based on circularity aspects.

Facilitate preparation and reuse in the second-hand market and the reverse supply chain.

Help manufacturers, governments, users to implement voluntary reporting and monitoring mechanisms to assess these qualities



- Elements (examples)
 - A unique product identifier: product, batch, item, part
 - Data carrier: scan code in the product
 - Details:
 - Codes, compliance, economic operators
 - Env. performance: materials (critical, hazardous), energy, weight, durability
 - Info for buyers and end-users (maintenance, repair, parts), treatment (end-of-life), operators (handling), market surveillance, customs
 - Specific details for each product category (verticals)
- Uses: need to know basis; evolutionary: already needed, used
 - More sustainable, circular products: design, reuse, ...
 - Traceability, transparency, verifiability: accountability
 - Informed choice: procurement
 - Incentives: EPR, reuse, return, recycling
 - Automation, smart decisions!



- Devices can be upgraded, reconfigured, repaired replacing parts:
 - Serialised, one chassis for life
 - Different hardware parts
 - What a recycler sees in an end-of-life product may be very different from the first product









This is the info for Digital Passport: a305d06175:ab0f5fab03

Hardware

Device

Chassis: Tower

Manufacturer: Dell Inc.

o Model: Optiplex 790

SerialNumber: 13SSB5J

Sku:

Type: Desktop

Version: 01

Version
 Components

 {'type': 'GraphicCard', 'model': '2nd Generation Core Processor Family Integrated Graphics Controller', 'manufacturer': 'Intel Corporation'}

{'type': 'Motherboard', 'model': '0j3c2f', 'manufacturer': 'Dell Inc.', 'serialNumber': '/13SSB5J/CN7360422H02JU/', 'version': 'A21', 'slots': 4, 'usb': 2, 'firewire': 0, 'serial': 1, 'pcmcia': 0, 'biosDate': '2018-02-11T23:00:00.000Z', 'ramSlots': 4, 'ramMaxSize': 32}

{'type': 'NetworkAdapter', 'model': '82579lm Gigabit Network Connection', 'manufacturer': 'Intel Corporation', 'serialNumber': 'D4:BE:D9:A2:12:86', 'variant': '04', 'speed': 1000, 'wireless': False}

{'type': 'Processor', 'model': 'Intel Celeron Cpu G530 @ 2.40ghz', 'manufacturer': 'Intel Corp.', 'brand': 'Celeron', 'speed': 1.677685, 'cores': 2, 'threads': 2, 'address': 64}

{'type': 'RamModule', 'model': 'Hmt351u6cfr8c-H9', 'manufacturer': 'Hynix/hyundai', 'serialNumber': '157AAB3C', 'size': 4096, 'speed': 1067, 'interface': 'DDR3', 'format': 'DIMM'}

{'type': 'RamModule', 'model': 'Ct51264bd160bj.c8f', 'manufacturer': '859b', 'serialNumber': 'E2555565', 'size': 4096, 'speed': 1067, 'interface': 'DDR3', 'format': 'DIMM'}

{'type': 'SolidStateDrive', 'model': 'Ct240bx500ssd1', 'serialNumber': '1927E18B23E1', 'variant': 'R013', 'size': 240057.409536, 'interface': 'ATA'}

 {'type': 'SoundCard', 'model': '6 Series/c200 Series Chipset Family High Definition Audio Controller', 'manufacturer': 'Intel Corporation'}

A working digital product passport for:

Chassis: a305d06175

Detailed hardware ID: ab0f5fab03





Thank you!

Questions? Let us know!



Email

leandro.navarro@upc.edu

tsbsg5@itu.int



Website

[www.itu.int/climate]

